



IFW

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Teruaki Kasai
Serial No.: 10/820,293
Filed: April 8, 2004
Title: "APPARATUS AND METHOD FOR PICKING UP SEMICONDUCTOR CHIP"
Docket No.: 36635

LETTER

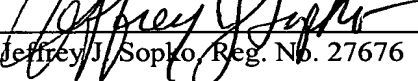
Mail Stop MISSING PARTS
Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Enclosed herewith are 8 sheets of formal drawings for filing in the above-identified application. Please note that applicant has not yet received a Notice to File Missing Parts of Application.

Respectfully submitted,

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By 
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April 29, 2004

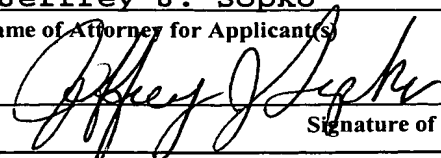
I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Missing Parts, Commissioner of Patents, P.O. Box 1450 Alexandria, Va. 22313-1450 on the date indicated below.

Jeffrey J. Sopko

Name of Attorney for Applicant(s)

04/29/2004

Date



Signature of Attorney